Specification for Approval

DEVICE NUMBER: BL-XUFGF361

SAMPLES ATTACHED AREA

PAGE DATE	1	2	3	4	5	6			CONTENTS
2015.11.10	1.0	1.0	1.0	1.0	1.0	1.0			Initial Released

FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING

佰鴻工業股份有限公司 BRIGHT LED ELECTRONICS CORP. 新北市板橋區和平路 19 號 3 樓 3F., No.19, He Ping Road, Ban Qiao Dist., New Taipei City, Taiwan

Tel: +886-2-29591090

ISSUED	APPROVED	PREPARED		
張	占	任		
2015.11.10	2015.11.10	2015.11.10		
孝 嚴	旭	穎		



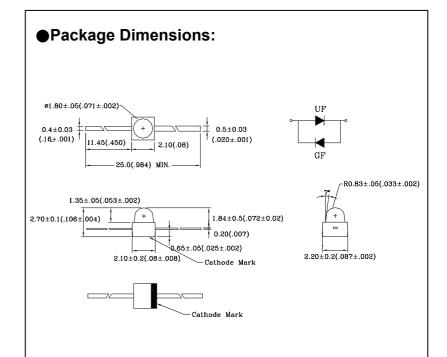
BL-XUFGF361

Features:

- Emitted Color: Super Red, .
 Super Yellow Green
- 2. Lens Appearance: Water Clear.
- 3. Low cost plastic package.
- 4. This product doesn't contain restriction Substance, comply ROHS standard.

Applications:

- Automotive: Dashboards, stop lamps, turn signals.
- 2. Backlighting: LCDs, Key pads advertising.
- 3. Status indicators: Comsumer & industrial electronics.
- 4. General use.



NOTES:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.10mm (0.004") unless otherwise specified.
- 3. Specifications are subject to change without notice.

■ Absolute Maximum Ratings(Ta=25°C)

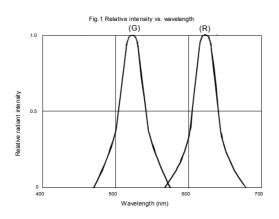
Parameter	Symbol	Super Red	Super Yellow Green	Unit
Power Dissipation	Pd	50	50	mW
Forward Current	I _F	20	20	mA
Peak Forward Current *1	I _{FP}	100	100	mA
Reverse Voltage	V_R		V	
Operating Temperature	Topr	-40℃~85℃		-
Storage Temperature	Tstg	-40℃~85℃		-
Soldering Temperature	Tsol	See Page 6		

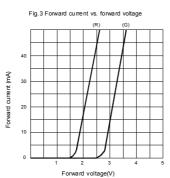


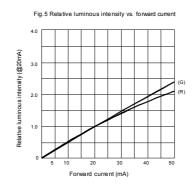
BL-XUFGF361

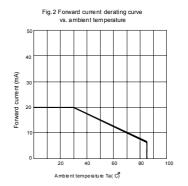
Parameter	Symbol	Condition	Color	Min.	Тур.	Max.	Unit
Forward Voltage	Vf	IF=20mA	Super Red Super Yellow Green	-	2.2 2.2	2.6 2.6	V
Luminous Intensity	lv	I _F =20mA	Super Red Super Yellow Green	-	317 200	-	mcd
Reverse Current	I_R	V _R =5V	Super Red Super Yellow Green	-	-	100 100	μΑ
Peak Wave Length	λр	I _F =20mA	Super Red Super Yellow Green	-	645 570	-	nm
Dominant Wave Length	λd	I _F =20mA	Super Red Super Yellow Green	625 566	-	635 576	nm
Spectral Line Half-width	Δλ	I _F =20mA	Super Red Super Yellow Green	-	20 30	-	nm
Viewing Angle	2θ _{1/2}	I _F =20mA	Super Red Super Yellow Green	-	35	-	deg

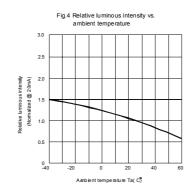
■ Typical Electro-Optical Characteristics Curves

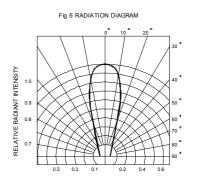














BL-XUFGF361

Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
	Operation Life	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS-C-7021 :B-1	Ta: Under room temperature Test time:1,000hrs IF=Product Recommended IF	0/32
Endurance	High Temperature High Humidity Storage	MIL-STD-202F:103B JIS-C-7021 :B-11	Ta:85±5℃ RH:90%-95% Test time:240hrs	0/32
Test	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	Ta:100±5℃ Test time:1,000hrs	0/32
	Low Temperature Storage	JIS-C-7021 :B-11	Ta: -40±5°C Test time=1,000hrs	0/32
	Temperature Cycling	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS-C-7021 :A-2	Ta:-35±5°C ~25±5°C ~85±5°C ~25±5°C 30min 5min 30min 5min	0/32
Environmental	Thermal Shock	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011(1991)	10min 10 min	0/32
Test	Wetting balance	MIL-STD-883:2003 MIL-STD-202F:208D MIL-STD-883D:2003	Ta:230±5°ℂ Time:5±0.5s	0/32
	Solder Resistance	MIL-STD-202F:210A MIL-STD-883D:1011 JIS-C-7021 :A-1	Ta:260±10°ℂ Time:10±1s	0/32

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure	
Forward voltage	$V_{F}(V)$	I _F =20mA	Initial Level*1.1	
Reverse current	$I_R(uA)$	V _R =5V	Over U*2	
Luminous intensity	lv (mcd)	I _F =20mA	Initial Level*0.7	

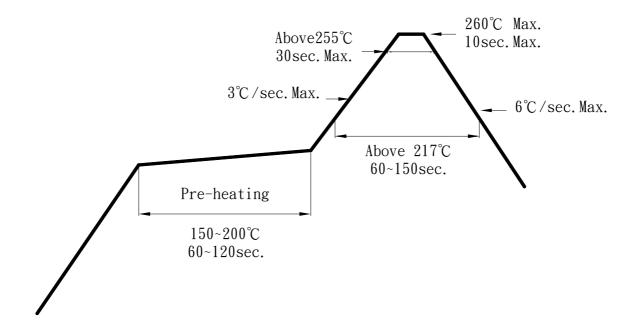
Note: 1.U means the upper limit of specified characteristics.

2. Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.



BL-XUFGF361

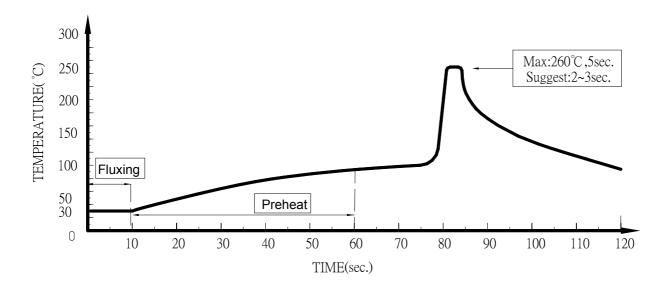
●IR-Reflow Soldering



- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
- 3. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

BL-XUFGF361

Dip Soldering



- 1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
- 4. Avoid rapid cooling during temperature ramp-down process
- 5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

IRON Soldering

300 $^{\circ}$ Within 3 sec.,One time only.



BL-XUFGF361

Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the BRIGHT LEDs within the rated figures. Also, caution should be taken not to overload BRIGHT LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as be subjected to reverse voltage when turning off the BRIGHT LEDs.

Storage:

In order to avoid the absorption of moisture, it is recommended to solder BRIGHT LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5°C-30°C (41°F)Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
- a. Completed within 168 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if: (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions: 48 hours at $60^{\circ}\text{C} \pm 3^{\circ}\text{C}$.

Package and Label of Products:

- (1) Package: Products are packed in one bag of 2000 pcs (one taping reel) and a label is attached on each bag.
- (2) Label:

